2	
⁻ 28	
0.8 199	4
83	O C
548 O/8	
17	

Form PTO-1595 **COVER SHEET** 102738907 U.S. Patent and Trademark Office (Rev. 03/01) PATENTS ONLY OMB No. 0651-0027 (exp. 5/31/2002) To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof 2. Name and address of receiving party(ies) 1. Name of conveying party(ies): (1) Akihiro Hayashi (04/23/04) Name: Nidek Co., Ltd. (2) Yoshinobu Hosoi (4/23/04) Internal Address: (3) Hidetaka Hoshino (4/23/04) Street Address: Additional name(s) of conveying party(ies) 7-9 Sakae-cho, Gamagori-shi x No 3. Nature of Conveyance: x Assignment Merger Security Agreement Change of Name City: Aichi-ken Other Zip: 443-0035 Country: Japan Additional name(s) & **Execution Date:** see above address(es) attached: Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the new application is: A. Patent Application No.(s): B. Patent No.(s): 10834982 Additional numbers attached? Yes 5. Name and address of party to whom correspondence 6. Total number of applications and concerning document should be mailed: patents involved: Name: Ronald P. Kananen RADER, FISHMAN & GRAUER PLLC 7. Total fee (37 CFR 3.41) 40.00 Enclosed Street Address: Authorized to be charged to deposit account 1233 20th Street, N.W. Authorized to be charged to credit card Suite 501 (Form 2038 enclosed) 8. Deposit account number:

DO NOT USE THIS SPACE

State:

DC

Zip:

20036

9. Statement and signature.

To the best of my knowledge and belief, the foregoing infó∲mation is true and correct and any attached copy

is a true copy of the original document.

Ronald P. Kananen, Reg. No. 24,104

Name of Person Signing

April 30, 2004 Signature Date

18-0013

(Attach duplicate copy of this page if paying by deposit account)

Total number of pages including cover r sheet, attachments, and documents:

05/2004 DBYRNE FC:8021

00000023 180013 10834982

40.00 DA

Citv:

Washington

Docket Number:

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

OPTOMETRIC APPARATUS

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, [NIDEK Co., Ltd.] located and doing business at [7-9 Sakae-cho, Gamagori-shi, Aichi-ken, 443-0035 Japan] (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

PATENT REEL: 015289 FRAME: 0249

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number:_____, Filing Date:_____. This assignment executed on the dates indicated below. Name of first inventor Akihiro HAYASHI Residence of first inventor 45-1 Kanayabashi-cho, Toyokawa-shi, Aichi-ken 442-0055 Japan Signature of first inventor Date of this assignment Akihito Hayashi Apr. 23, 2004 Name of second inven-Yoshinobu HOSOI Residence of second inventor 1-12 Sakae-cho, Gamagori-shi, Aichi-ken 443-0035 Japan Signature of second inventor Date of this assignment Joshinobu Hosoi Apr. 23. 2004 Name of third inventor Hidetaka HOSHINO Residence of third inventor 12-6 Higashiyamam, Ashinoya, Kota-cho, Nukata-gun, Aichi-ken 444-0116 Japan Signature of third inventor Date of this assignment Hidetaka Hoshin

RECORDED: 04/30/2004

PATENT REEL: 015289 FRAME: 0250

Apr. 23.2004